# onsemi

## 6-Pin DIP Random-Phase Triac Driver Optocoupler (600 Volt Peak)

## MOC3051M, MOC3052M, MOC3053M

The MOC3051M, MOC3052M and MOC3053M consist of a GaAs infrared emitting diode optically coupled to a non-zero- crossing silicon bilateral AC switch (triac). These devices isolate low voltage logic from 115  $V_{AC}$  and 240  $V_{AC}$  lines to provide random phase control of high current triacs or thyristors. These devices feature greatly enhanced static dv/dt capability to ensure stable switching performance of inductive loads.

#### Features

- Excellent I<sub>FT</sub> Stability—IR Emitting Diode Has Low Degradation
- 600 V Peak Blocking Voltage
- Safety and Regulatory Approvals
  - UL1577, 4,170 VAC<sub>RMS</sub> for 1 Minute
  - ◆ DIN EN/IEC60747-5-5

#### **Typical Applications**

- Solenoid/Valve Controls
- Lamp Ballasts
- Static AC Power Switch
- Interfacing Microprocessors to 115  $V_{AC}$  and 240  $V_{AC}$  Peripherals
- Solid State Relay
- Incandescent Lamp Dimmers
- Temperature Controls
- Motor Controls





#### **PIN CONNECTIONS**



#### ORDERING INFORMATION

See detailed ordering, marking and shipping information on page 9 of this data sheet.

#### SAFETY AND INSULATIONS RATINGS

As per DIN EN/IEC 60747–5–5, this optocoupler is suitable for "safe electrical insulation" only within the safety limit data. Compliance with the safety ratings shall be ensured by means of protective circuits.

| Parameter   |                        | Characteristics |
|---|------------------------|-----------------|
| Installation Classifications per DIN VDE 0110/1.89 Table 1, | < 150 V <sub>RMS</sub> | I–IV            |
| For Rated Mains Voltage                                     | < 300 V <sub>RMS</sub> | I–IV            |
| Climatic Classification                                     |                        |                 |
| Pollution Degree (DIN VDE 0110/1.89)                        |                        | 2               |
| Comparative Tracking Index                                  |                        | 175             |

| Symbol            | Parameter  | Value             | Unit  |
|-------------------|--|-------------------|-------|
| V <sub>PR</sub>   | Input-to-Output Test Voltage, Method A, $V_{IORM} x 1.6 = V_{PR}$ , Type and Sample Test with $t_m = 10$ s, Partial Discharge < 5 pC   | 1360              | Vpeak |
|                   | Input-to-Output Test Voltage, Method B, $V_{IORM} x 1.875 = V_{PR}$ , 100% Production Test with $t_m = 1 s$ , Partial Discharge < 5 pC | 1594              | Vpeak |
| V <sub>IORM</sub> | Maximum Working Insulation Voltage   | 850               | Vpeak |
| V <sub>IOTM</sub> | Highest Allowable Over-Voltage   | 6000              | Vpeak |
|                   | External Creepage  | ≥ 7               | mm    |
|                   | External Clearance   | ≥ 7               | mm    |
|                   | External Clearance (for Option TV, 0.4" Lead Spacing)  | ≥ 10              | mm    |
| DTI               | Distance Through Insulation (Insulation Thickness)   | ≥ 0.5             | mm    |
| R <sub>IO</sub>   | Insulation Resistance at $T_S$ , $V_{IO}$ = 500 V  | > 10 <sup>9</sup> | Ω     |

#### **MAXIMUM RATINGS** $T_A = 25^{\circ}C$ unless otherwise specified.

| Symbol           | Parameter Va                                   |                    | Unit  |
|------------------|--|--------------------|-------|
| TOTAL DE         | EVICE  | •                  |       |
| T <sub>STG</sub> | Storage Temperature                            | -40 to +125        | °C    |
| T <sub>OPR</sub> | Operating Temperature                          | -40 to +85         | °C    |
| Τ <sub>J</sub>   | Junction Temperature Range                     | -40 to +100        | °C    |
| T <sub>SOL</sub> | Lead Solder Temperature                        | 260 for 10 seconds | °C    |
| PD               | Total Device Power Dissipation at 25°C Ambient | 330                | mW    |
|                  | Derate Above 25°C                              | 4.4                | mW/°C |
| EMITTED          |  |                    |       |

#### EMITTER

| ١ <sub>F</sub> | Continuous Forward Current              | 60   | mA    |
|----------------|---|------|-------|
| V <sub>R</sub> | Reverse Voltage                         | 3    | V     |
| PD             | Total Power Dissipation at 25°C Ambient | 100  | mW    |
|                | Derate Above 25°C                       | 1.33 | m₩/°C |

#### DETECTOR

| V <sub>DRM</sub> | Off-State Output Terminal Voltage                                | 600 | V     |
|------------------|--|-----|-------|
| I <sub>TSM</sub> | Peak Non-Repetitive Surge Current (Single Cycle 60 Hz Sine Wave) | 1   | А     |
| PD               | Total Power Dissipation at 25°C Ambient                          | 300 | mW    |
|                  | Derate Above 25°C  | 4   | mW/°C |

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

#### **ELECTRICAL CHARACTERISTICS** ( $T_A = 25^{\circ}C$ unless otherwise specified) **INDIVIDUAL COMPONENT CHARACTERISTICS**

| Symbol           | Parameters                                 | Characteristic   | Min  | Тур  | Max  | Unit |
|------------------|--|--|------|------|------|------|
| EMITTER          |  |  |      |      |      |      |
| VF               | Input Forward Voltage                      | I <sub>F</sub> = 10 mA                                   |      | 1.18 | 1.50 | V    |
| I <sub>R</sub>   | Reverse Leakage Current                    | V <sub>R</sub> = 3 V                                     |      | 0.05 | 100  | μΑ   |
| DETECTO          | R  |  |      |      |      |      |
| I <sub>DRM</sub> | Peak Blocking Current, Either Direction    | V <sub>DRM</sub> = 600 V, I <sub>F</sub> = 0<br>(Note 1) |      | 10   | 100  | nA   |
| $V_{\text{TM}}$  | Peak On-State Voltage, Either Direction    | $I_{TM} = 100 \text{ mA peak},$<br>$I_F = 0$             |      | 2.2  | 2.5  | V    |
| dv/dt            | Critical Rate of Rise of Off-State Voltage | I <sub>F</sub> = 0, V <sub>DRM</sub> = 600 V             | 1000 |      |      | V/μs |

#### TRANSFER CHARACTERISTICS

| Symbol          | DC Characteristic                        | Test Conditions        | Device                 | Min                    | Тур      | Max | Unit |    |  |
|-----------------|--|------------------------|------------------------|------------------------|----------|-----|------|----|--|
| I <sub>FT</sub> | LED Trigger Current,<br>Either Direction | Main Terminal          | MOC3051M               |                        |          | 15  | mA   |    |  |
|                 | Either Direction Voltage = 5 V (Note 2)  | Voltage = 3 V (Note 2) | voltage = 3 v (note 2) | voltage = 5 v (note 2) | MOC3052M |     |      | 10 |  |
|                 |  |                        | MOC3053M               |                        |          | 6   |      |    |  |
| Ι <sub>Η</sub>  | Holding Current,<br>Either Direction     |                        | All                    |                        | 540      |     | μΑ   |    |  |

#### **ELECTRICAL CHARACTERISTICS** ( $T_A = 25^{\circ}C$ unless otherwise specified) (continued) **INDIVIDUAL COMPONENT CHARACTERISTICS**

| Symbol           | Characteristic                          | Test Conditions         | Min  | Тур              | Max | Unit               |
|------------------|---|-------------------------|------|------------------|-----|--------------------|
| ISOLATION        | ISOLATION CHARACTERISTICS               |                         |      |                  |     |                    |
| V <sub>ISO</sub> | Input-Output Isolation Voltage (Note 3) | f = 60 Hz, t = 1 Minute | 4170 |                  |     | VAC <sub>RMS</sub> |
| R <sub>ISO</sub> | Isolation Resistance                    | $V_{I-O} = 500 V_{DC}$  |      | 10 <sup>11</sup> |     | Ω                  |
| C <sub>ISO</sub> | Isolation Capacitance                   | V = 0 V, f = 1 MHz      |      | 0.2              |     | pF                 |

1. Test voltage must be applied within dv/dt rating.

 All devices will trigger at an I<sub>F</sub> value greater than or equal to the maximum I<sub>FT</sub> specification. For optimum operation over temperature and lifetime of the device, the LED should be biased with an I<sub>F</sub> that is at least 50% higher than the maximum I<sub>FT</sub> specification. The I<sub>F</sub> should not exceed the absolute maximum rating of 60 mA.

Example: For MOC3052M, the minimum  $I_F$  bias should be 10 mA x 150% = 15 mA.

3. Isolation voltage, V<sub>ISO</sub>, is an internal device dielectric breakdown rating. For this test, pins 1 and 2 are common, and pins 4, 5 and 6 are common.

#### **TYPICAL CHARACTERISTICS**







2

3

100

80

100

www.onsemi.com 5

Figure 5. Holding Current vs. Ambient

Temperature

#### **APPLICATIONS INFORMATION**

#### **Basic Triac Driver Circuit**

The random phase triac drivers MOC3051M, MOC3052M and MOC3053M can allow snubberless operations in applications where load is resistive and the external generated noise in the AC line is below its guaranteed dv/dt withstand capability. For these applications, a snubber circuit is not necessary when a noise insensitive power triac is used. Figure 7 shows the circuit diagram. The triac driver is directly connected to the triac main terminal 2 and a series resistor R which limits the current to the triac driver. Current limiting resistor R must have a minimum value which restricts the current into the driver to maximum 1 A.

The power dissipation of this current limiting resistor and the triac driver is very small because the power triac carries the load current as soon as the current through driver and current limiting resistor reaches the trigger current of the power triac. The switching transition times for the driver is only one micro second and for power triacs typical four micro seconds.

#### **Triac Driver Circuit for Noisy Environments**

When the transient rate of rise and amplitude are expected to exceed the power triacs and triac drivers maximum ratings a snubber circuit as shown in Figure 8 is recommended. Fast transients are slowed by the R–C snubber and excessive amplitudes are clipped by the Metal Oxide Varistor MOV.

#### Triac Driver Circuit for Extremely Noisy Environments

As specified in the noise standards IEEE472 and IEC255-4.

Industrial control applications do specify a maximum transient noise dv/dt and peak voltage which is super–imposed onto the AC line voltage. In order to pass this environment noise test a modified snubber network as shown in Figure 9 is recommended.

#### LED Trigger Current versus Temperature

Recommended operating LED control current  $I_F$  lies between the guaranteed  $I_{FT}$  and absolute maximum  $I_F$ . Figure 3 shows the increase of the trigger current when the device is expected to operate at an ambient temperature below 25°C. Multiply the datasheet guaranteed  $I_{FT}$  with the normalized  $I_{FT}$  shown on this graph and an allowance for LED degradation over time.

Example:

$$\begin{split} I_{FT} = 10 \text{ mA, LED degradation factor} = 20\% \\ I_F \text{ at } -40^\circ\text{C} = 10 \text{ mA} \times 1.25 \times 120\% = 15 \text{ mA} \end{split}$$

#### LED Trigger Current vs. Pulse Width

Random phase triac drivers are designed to be phase controllable. They may be triggered at any phase angle within the AC sine wave. Phase control may be accomplished by an AC line zero cross detector and a variable pulse delay generator which is synchronized to the zero cross detector. The same task can be accomplished by a microprocessor which is synchronized to the AC zero crossing. The phase controlled trigger current may be a very short pulse which saves energy delivered to the input LED. LED trigger pulse currents shorter than 100 µs must have increased amplitude as shown on Figure 4. This graph shows the dependency of the trigger current I<sub>FT</sub> versus the pulse width. IFT in this graph is normalized in respect to the minimum specified IFT for static condition, which is specified in the device characteristic. The normalized IFT has to be multiplied with the devices guaranteed static trigger current.

Example: I<sub>FT</sub> = 10 mA, Trigger PW = 4  $\mu$ s I<sub>F</sub> (pulsed) = 10 mA  $\times$  3 = 30 mA

#### Minimum LED Off Time in Phase Control Applications

In phase control applications, one intends to be able to control each AC sine half wave from 0° to 180°. Turn on at 0° means full power and turn on at 180° means zero power. This is not quite possible in reality because triac driver and triac have a fixed turn on time when activated at zero degrees. At a phase control angle close to 180° the driver's turn on pulse at the trailing edge of the AC sine wave must be limited to end 200  $\mu$ s before AC zero cross as shown in Figure 10. This assures that the triac driver has time to switch off. Shorter times may cause loss of control at the following half cycle.

#### Static dv/dt

Critical rate of rise of off-state voltage or static dv/dt is a triac characteristic that rates its ability to prevent false triggering in the event of fast rising line voltage transients when it is in the off-state. When driving a discrete power triac, the triac driver optocoupler switches back to off-state once the power triac is triggered. However, during the commutation of the power triac in application where the load is inductive, both triacs are subjected to fast rising voltages. The static dv/dt rating of the triac driver optocoupler and the commutation in snubber circuit design to prevent false triggering and commutation failure.



Figure 7. Basic Driver Circuit



Typical Snubber values  $R_S = 33 \Omega$ ,  $C_S = 0.01 \mu F$ MOV (Metal Oxide Varistor) protects power triac and driver from transient overvoltages >  $V_{DRM}$  max





Figure 9. Triac Driver Circuit for Extremely Noisy Environments





#### **REFLOW PROFILE**



Figure 11. Reflow Profile

| Profile Feature                                    | Pb-Free Assembly Profile  |
|--|---------------------------|
| Temperature Minimum (Tsmin)                        | 150°C                     |
| Temperature Maximum (Tsmax)                        | 200°C                     |
| Time (t <sub>S</sub> ) from (Tsmin to Tsmax)       | 60 seconds to 120 seconds |
| Ramp-up Rate (T <sub>L</sub> to T <sub>P</sub> )   | 3°C/second maximum        |
| Liquidous Temperature (TL)                         | 217°C                     |
| Time $(t_L)$ Maintained Above $(T_L)$              | 60 seconds to 150 seconds |
| Peak Body Package Temperature                      | 260°C +0°C / –5°C         |
| Time (t <sub>P</sub> ) within 5°C of 260°C         | 30 seconds                |
| Ramp-down Rate (T <sub>P</sub> to T <sub>L</sub> ) | 6°C/second maximum        |
| Time 25°C to Peak Temperature                      | 8 minutes maximum         |

#### **ORDERING INFORMATION** (Note 4)

| Device       | Package   | Shipping                   |
|--------------|---|----------------------------|
| MOC3051M     | DIP 6-Pin   | Tube (50 Units)            |
| MOC3051SM    | SMT 6-Pin (Lead Bend)                                       | Tube (50 Units)            |
| MOC3051SR2M  | SMT 6-Pin (Lead Bend)                                       | Tape and Reel (1000 Units) |
| MOC3051VM    | DIP 6-Pin, DIN EN/IEC60747-5-5 Option                       | Tube (50 Units)            |
| MOC3051SVM   | SMT 6-Pin (Lead Bend),<br>DIN EN/IEC60747-5-5 Option        | Tube (50 Units)            |
| MOC3051SR2VM | SMT 6-Pin (Lead Bend),<br>DIN EN/IEC60747-5-5 Option        | Tape and Reel (1000 Units) |
| MOC3051TVM   | DIP 6–Pin, 0.4" Lead Spacing,<br>DIN EN/IEC60747–5–5 Option | Tube (50 Units)            |

4. The product orderable part number system listed in this table also applies to the MOC3052M and MOC3053M product families.

ON

PDIP6 8.51x6.35, 2.54P CASE 646BX ISSUE O

DATE 31 JUL 2016







#### NOTES:

- A) NO STANDARD APPLIES TO THIS PACKAGE.
- B) ALL DIMENSIONS ARE IN MILLIMETERS.
- C) DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH, AND TIE BAR EXTRUSION

| DOCUMENT NUMBER:  | 98AON13449G   | Electronic versions are uncontrolled except when accessed directly from the Document Reposi<br>Printed versions are uncontrolled except when stamped "CONTROLLED COPY" in red.  |   |  |
|---|---|---|---|--|
| DESCRIPTION:  | PDIP6 8.51X6.35, 2.54P  |   | PAGE 1 OF 1   |  |
| ON Semiconductor reserves the right<br>the suitability of its products for any pa | to make changes without further notice to an<br>articular purpose, nor does ON Semiconducto | stries, LLC dba ON Semiconductor or its subsidiaries in the United States<br>y products herein. ON Semiconductor makes no warranty, representation<br>r assume any liability arising out of the application or use of any product or<br>ncidental damages. ON Semiconductor does not convey any license under | or guarantee regarding<br>r circuit, and specifically |  |

## ON

#### PDIP6 8.51x6.35, 2.54P CASE 646BY ISSUE A

#### DATE 15 JUL 2019



| DOCUMENT NUMBER:  | 98AON13450G   | Electronic versions are uncontrolled except when accessed directly from the Document Repositor<br>Printed versions are uncontrolled except when stamped "CONTROLLED COPY" in red.   |   |  |  |
|---|---|---|---|--|--|
| DESCRIPTION:  | PDIP6 8.51x6.35, 2.54P  | PAGE 1 OF   |   |  |  |
| ON Semiconductor reserves the right<br>the suitability of its products for any pa | to make changes without further notice to an<br>articular purpose, nor does ON Semiconducto | stries, LLC dba ON Semiconductor or its subsidiaries in the United States<br>y products herein. ON Semiconductor makes no warranty, representation<br>r assume any liability arising out of the application or use of any product or<br>icidental damages. ON Semiconductor does not convey any license under | or guarantee regarding<br>r circuit, and specifically |  |  |



PDIP6 8.51x6.35, 2.54P CASE 646BZ ISSUE O

DATE 31 JUL 2016







NOTES:

- A) NO STANDARD APPLIES TO THIS PACKAGE.
- B) ALL DIMENSIONS ARE IN MILLIMETERS.
- C) DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH, AND TIE BAR EXTRUSION

| DOCUMENT NUMBER:  | 98AON13451G            | Electronic versions are uncontrolled except when accessed directly from the Document Repository.<br>Printed versions are uncontrolled except when stamped "CONTROLLED COPY" in red. |             |
|---|------------------------|---|-------------|
| DESCRIPTION:  | PDIP6 8.51X6.35, 2.54P |   | PAGE 1 OF 1 |
| ON Semiconductor and are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries.<br>ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding<br>the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically<br>disclaims any and all liability, including without limitation special, consequential or incidental damages. ON Semiconductor does not convey any license under its patent rights nor the<br>rights of others |                        |   |             |

onsemi, ONSEMI, and other names, marks, and brands are registered and/or common law trademarks of Semiconductor Components Industries, LLC dba "onsemi" or its affiliates and/or subsidiaries in the United States and/or other countries. onsemi owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of onsemi's product/patent coverage may be accessed at www.onsemi.com/site/pdf/Patent-Marking.pdf. onsemi reserves the right to make changes at any time to any products or information herein, without notice. The information herein is provided "as-is" and onsemi makes no warranty, representation or guarantee regarding the accuracy of the information, product features, availability, functionality, or suitability of its products for any particular purpose, nor does onsemi assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using **onsemi** products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by **onsemi**. "Typical" parameters, which may be provided in **onsemi** data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. **onsemi** does not convey any license under any of its intellectual property rights nor the rights of others. **onsemi** products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use onsemi products for any such unintended or unauthorized application, Buyer shall indemnify and hold onsemi and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that **onsemi** was negligent regarding the design or manufacture of the part. **onsemi** is an Equal Opportunity/Affirmative Action Employer. This literature is subject to all applicable copyright laws and is not for resale in any manner.

#### PUBLICATION ORDERING INFORMATION

LITERATURE FULFILLMENT:

#### TECHNICAL SUPPORT

Email Requests to: orderlit@onsemi.com

onsemi Website: www.onsemi.com

North American Technical Support: Voice Mail: 1 800–282–9855 Toll Free USA/Canada Phone: 011 421 33 790 2910

Europe, Middle East and Africa Technical Support: Phone: 00421 33 790 2910 For additional information, please contact your local Sales Representative